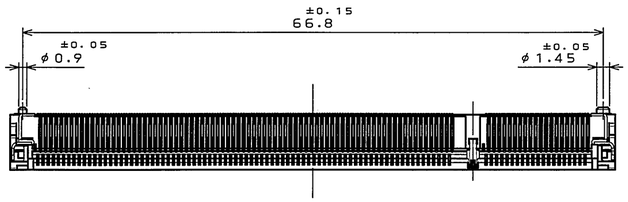
図面番号(DRAWING NO.) SJ101278

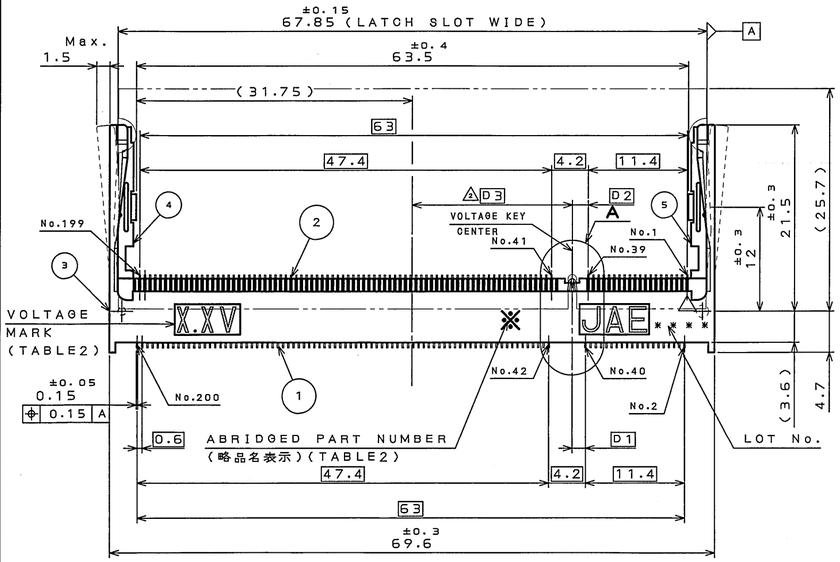
版数 REV.	年月日 DATE	DCN NO.	変更内容 DESCRIPTION	製図 DR.	担当 CHK.	査閲 APPD.	承認 APPD.
2	10.Feb.2006	059307	CORRECTION OF ERROR IN WRITTING	E.MURANO	Y.YAHIRO	—	K.Hasegawa

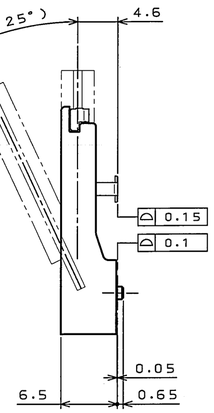
DESIGNATION

MM50−200B＊−E1RE

- SERIES PREFIX シリーズ名
- NO. OF CONTACTS 芯数
- SOCKET TYPE ソケットタイプ B:LATCH TYPE SMT
- KEYING TYPE(DETAIL A) キィタイプ 2:TYPE B(1.8V) 1:TYPE A(2.5V)
- CONTACT FINISH 接点仕上げ 1:Au(0.1μm MIN) OVER NI
- MODIFY CODE モディファイコード E:6.5mm HIGHT
- R :REVERSE NONE:STANDARD
- 錫または錫合金(無鉛) (LEAD FREE)TIN/TIN ALLOY







DETAIL A
(SCALE 5:1)
(REF.TABLE1)

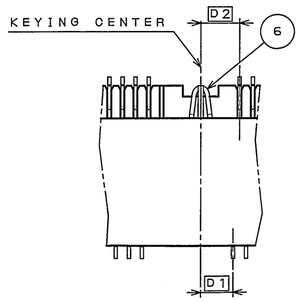
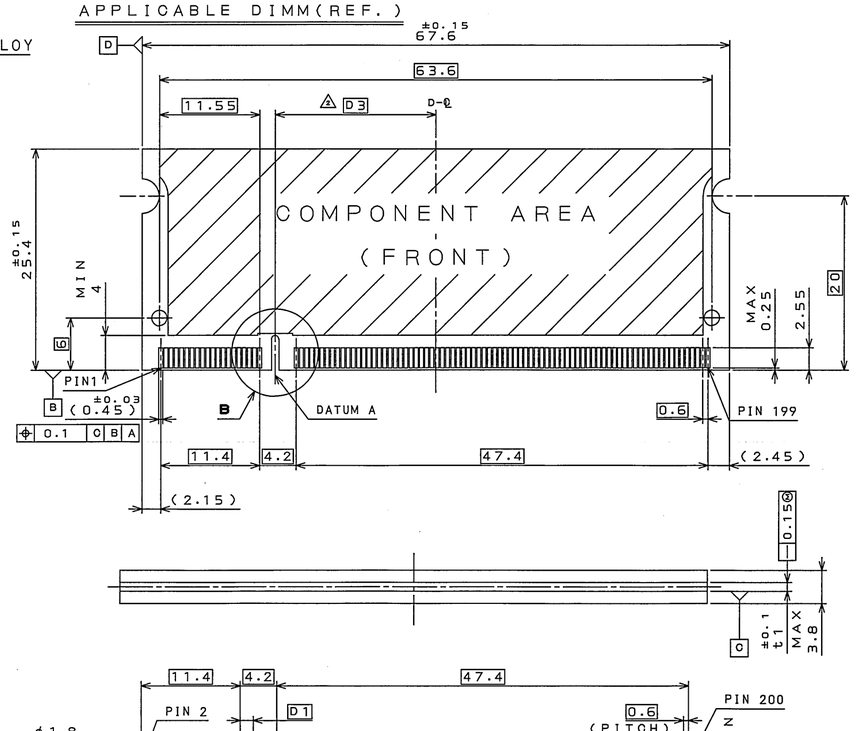
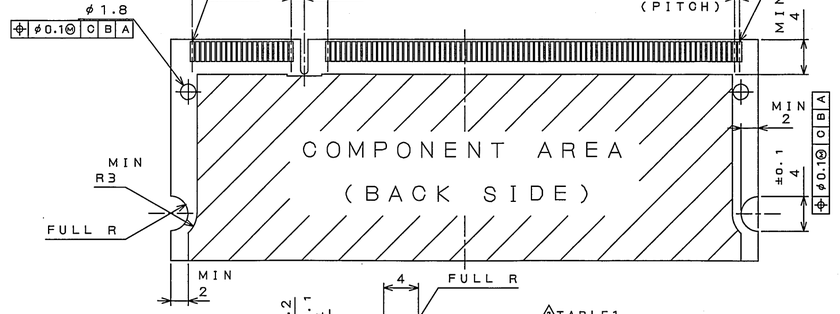


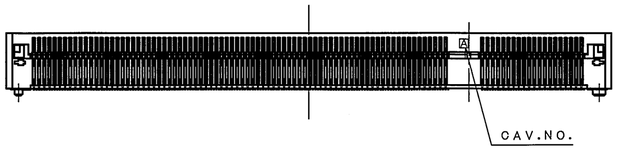
TABLE2
DISCRIMINATION MARK

PARTS NAME	VOLTAGE MARK	ABRIDGED PART NUMBER
MM50-200B1-E1RE	2.5V	E1RE
MM50-200B2-E1RE	1.8V	2−E1RE

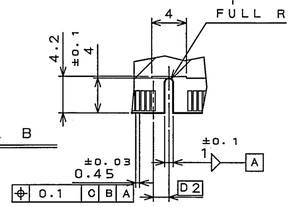
APPLICABLE DIMM(REF.)







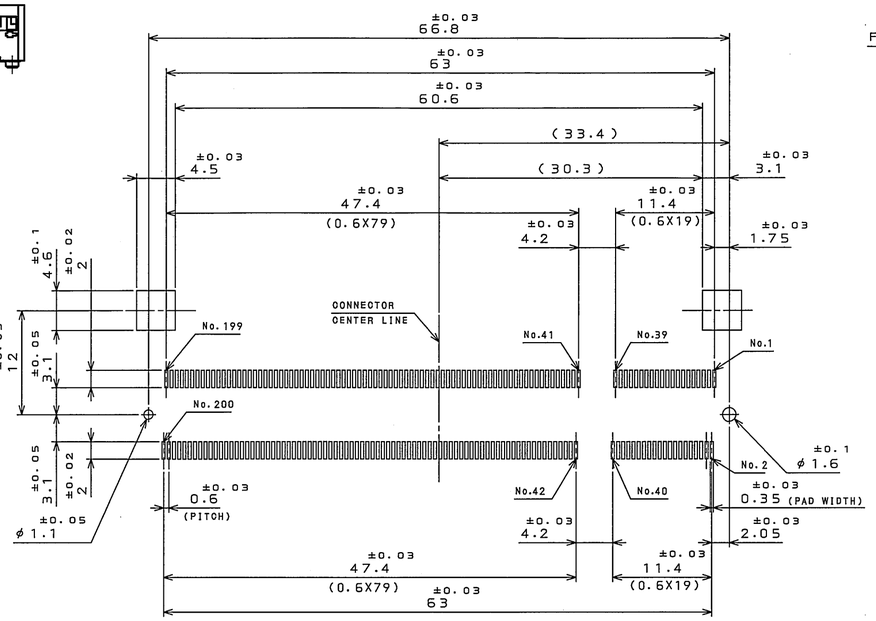
DETAIL B

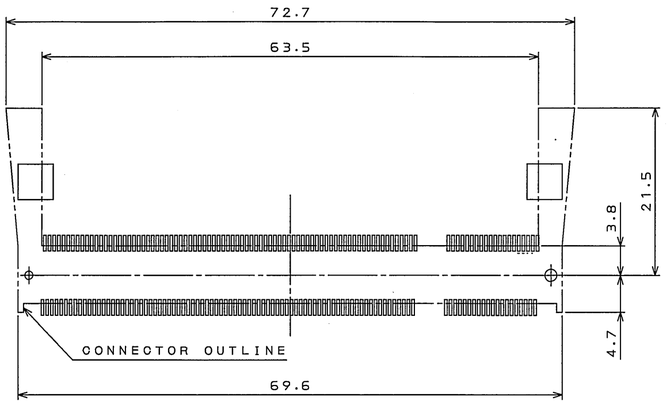


△TABLE1
MECHANICAL KEYING

POWER SPPLY	D1	D2	D3
2.5V(TYPE A)	1.5	1.8	18.45
1.8V(TYPE B)	2.4	2.7	17.55

APPLICABLE P.C.B. DIMENSION(REF.)
適合基板寸法(参考)





CONNECTOR MOUNTED AREA(REF.)

NO.	DESCRIPTION	QTY.	MATERIAL	FINISH	REMARKS
6	KEY	1	STAINLESS	—	—
5	HOLD DOWN 2	1	PHOSPHOR BRONZE	TIN PLATING	—
4	HOLD DOWN 1	1	PHOSPHOR BRONZE	TIN PLATING	—
3	INSULATOR	1	GLASS FILLED LCP	—	UL94 V-0 COLOR WHITE
2	BOTTOM SIDE CONTACT	100	PHOSPHOR BRONZE	CONTACT AREA:Au(0.1μm MIN) OVER NI SOLDERING AREA:GOLD FLASH OVER NI	—
1	TOP SIDE CONTACT	100	PHOSPHOR BRONZE	CONTACT AREA:Au(0.1μm MIN) OVER NI SOLDERING AREA:GOLD FLASH OVER NI	—

仕様書(SPECIFICATION): JACS-1655-01
第1版(ORIGINAL DATE): 20.May.2004
一般公差(GENERAL TOLERANCE) 寸法(DIMENSION): . ±0.8 / .X ±0.4 / .XX ±0.1 / .XXX± 角度(ANGLES): X° ± / XºX' ±
製図 DR.: —
担当 CHK.: R.KATOU
査閲 APPD.: Y.YAHIRO
承認 APPD.: S.KASHIWAGI
尺度(SCALE): 2:1
シリーズ(SERIES): MM50
名称(TITLE): MM50 −200B＊−E1RE
質量(MASS):
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SIZE A2

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